

## PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT3739253

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
ARAVIND GANESAN	06/01/2015
DEEPAK KARKALA	06/01/2015
RAJESH MUNDHADA	06/01/2015
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	SIGNALCHIP INNOVATIONS PRIVATE LIMITED
<b>Street Address:</b>	4C-116, 4TH CROSS,
<b>Internal Address:</b>	OMBR LAYOUT, BANASWADI
<b>City:</b>	BENGALURU
<b>State/Country:</b>	INDIA
<b>Postal Code:</b>	560043
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	15043803
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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<b>ATTORNEY DOCKET NUMBER:</b>	MY091011US
<b>NAME OF SUBMITTER:</b>	D. AUSTIN BONDERER
<b>SIGNATURE:</b>	/D. Austin Bonderer/
<b>DATE SIGNED:</b>	02/15/2016
<b>Total Attachments: 3</b>	
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PATENT APPLICATION ASSIGNMENT AGREEMENT

THIS AGREEMENT is made this 1<sup>st</sup> day of June, 2015, by and between 1.Aravind Ganesan, with address 101 Block 1, Harsha Meadows, SuddaguntePalya, C. V. Raman Nagar, Bangalore 560093, India, 2.Deepak Karkala, with address Sharan Ville, Flat No 302, KadriShivbagh Road, Near Abharan Jewellers, Mangalore 575002, India, and 3.Rajesh Mundhada, with address H-905, Rohan Vasantha, Varthur Road, Marthahalli, Bangalore-560037, India collectively (hereinafter "ASSIGNORS") and Signalchip Innovations Private Limited ("Assignee") whose address is 4C-116, 4th Cross, OMBR Layout, Banaswadi, Bangalore 560043, Karnataka, INDIA and collectively the "Parties".

WHEREAS, Assignors have invented "METHOD AND SYSTEM FOR SYMBOL LEVEL INTERFERENCE CANCELLATION AT A RECEIVER FOR MULTIUSER DETECTION" (the "Invention"), disclosed in an application for United States Letters Patent (the "Patent Application") identified below.

WHEREAS, Assignee wishes to acquire all right, title and interest in the Patent Application, and Assignors wishes to sell its interest in the Patent Application to Assignee.

NOW THEREFORE, in consideration of the mutual promises, covenants, warranties, and other good and valuable consideration set forth herein, the Parties agree as follows:

1. Patent Application.

The Patent Application can be identified by:

Application Number: To be filed

Date of filing: To be filed

Name(s) of inventor: Mr. AravindGanesan, Mr. Deepak Karkala, and Mr. Rajesh Mundhada.

Name of invention: METHOD AND SYSTEM FOR SYMBOL LEVEL INTERFERENCE CANCELLATION AT A RECEIVER FOR MULTIUSER DETECTION

2. Assignment. Assignors hereby assigns to Assignee, its successors, representatives and assigns, all right, title and interest in the Patent Application and in all divisions, renewals and continuations thereof, and in all letters patent granted thereon, including all reexaminations, extensions and reissues thereof. Assignors hereby requests the Commissioner of Patents of the United States to issue all Letters Patent granted pursuant to the Patent Application to Assignee, its successors, representatives and assigns.

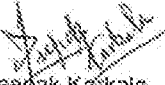
3. **Payment.** In consideration of the assignment of the Patent Application pursuant to this Agreement, and of the promises and covenants contained herein, Assignee shall pay to Assignors a fee in the amount of INR 5, payable in cash, and for other good and valuable consideration, the receipt of both which is hereby acknowledged.
4. **Assignor's Representations and Warranties.** Assignors hereby represent and warrant that it has the legal right and authority to execute this Agreement, and to validly assign the entire interest in the Patent Application to Assignee. Assignors further represent and warrant that it has not executed any other agreement that would conflict with the terms of this Agreement, nor shall it execute any such agreement in the future.
5. **Further Actions.** Assignors hereby agrees to execute any further agreements and to take any further actions necessary to aid Assignee in perfecting its interest in the Patent Application, and in any letters patent granted thereon, and in enforcing any and all protections or privileges deriving from the Patent Application or from said letters patent.
6. **Governing Law.** This Agreement shall be construed in accordance with, and governed in all respects by, the laws of the State of Karnataka, India without regard to conflicts of law principles.
7. **Counterparts.** This Agreement may be executed in several counterparts, each of which shall constitute an original and all of which, when taken together, shall constitute one agreement.
8. **Severability.** If any part or parts of this Agreement shall be held unenforceable for any reason, the remainder of this Agreement shall continue in full force and effect. If any provision of this Agreement is deemed invalid or unenforceable by any court of competent jurisdiction, and if limiting such provision would make the provision valid, then such provision shall be deemed to be construed as so limited.
9. **Notice.** Any notice required or otherwise given pursuant to this Agreement shall be in writing and mailed certified return receipt requested, postage prepaid, or delivered by overnight delivery service, addressed as follows:  
  
If to Assignors; at addresses given at Para 1 of this agreement.  
  
If to Assignee: Signalchip Innovations Private Limited, 4C-116, 4th Cross, OMBR Layout, Banaswadi, Bangalore 560043, Karnataka, INDIA.
10. **Headings.** The headings for section herein are for convenience only and shall not affect the meaning of the provisions of this Agreement.

date of this Agreement. There are no other promises, conditions, understandings or other agreements, whether oral or written, relating to the subject matter of this Agreement.  
IN WITNESS WHEREOF, the parties have caused this Agreement to be executed the day and year first above written.

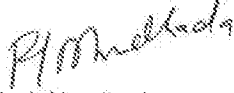
ASSIGNORS



Aravind Ganesan

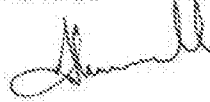


Deepak Karkala



Rajesh Mundhada

ASSIGNEE



For Signalchip Innovations Private Limited